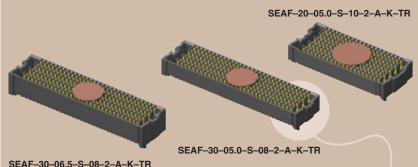




Mates with:

SEAF

SEAM, SADL, SEAC (Requires -LP)



SEAF-30-06.5-S-08-2-A-K-TR

OPEN PIN FIELD ARRAY SEAF SERIES

Up to

LEAD

STYLE

LEAD

STYLE

from

chart

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?SEAF

Insulator Material: Black LCP

Contact Material: Gopper Alloy
Operating Temp Range:

55°C to +125°C Plating:

Au over 50μ" (1,27μm) Ni Contact Resistance: 5.5 mΩ

Working Voltage: 240 VAC RoHS Compliant: Yes

Processing:

8

8 8

8

8

8

8

8

8

8

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8

8

SEAM

LEAD

STYLE

-02.0

-03.0

-03.5

-06.5

-07.0

-09.0

-11.0

MATED HEIGHTS*

-05.0

7mm

8mm

8.5mm

11.5mm

12mm

14mm

16mm

*Processing conditions will affect mated height.

SEAF LEAD STYLE

-06.0

8mm

9mm

9.5mm

12.5mm

13mm

15mm

17mm

-06.5

8.5mm

9.5mm

10mm

13mm

13.5mm

15.5mm

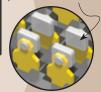
17.5mm

Max Processing Temp: 230°C for 60 seconds, or 260°C for 20 seconds 3x Lead-Free Solderable: Yes OPEN PIN FIELD INTERCONNECTS

500 Pins

5, 8 and 10 row footprint compatible with SamArray®. Samples recommended.

> Lead-Free Solder **Charge Terminations** (Tin/Lead also available)



Low Insertion/ Extraction Forces Rated @ -3dB Insertion Loss 7mm Stack Height Single-Ended Signaling 9.5 GHz / 19 Gbps Differential Pair Signaling 10.5 GHz / 21 Gbps

NO. OF

ROWS

-04

Rows

-10

CURRENT RATING AMBIENT SEAM/SEAF TEMP 20°C 2.3A 40°C 2A 60°C 1.75A 1.14A 95°C 30 ADJACENT POSITIONS POWERED

OPTION

Industry Standards

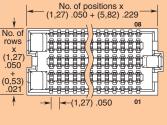
PISMO 2 VITA 47 VITA 57 otocols

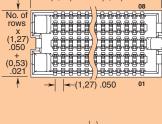
Fibre Channel Rapid 1/0 PCI Express® SATA Infiniband Download app notes at www.samtec.com/appnote Contact SIG @ samtec.com for questions on protocols

NO. PINS

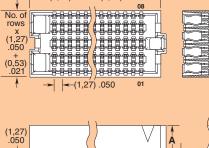
PER ROW

LEAD STYLE	Α	
-05.0	(5,05) .199	
-06.0	(6,05) .238	
-06.5	(6,55)	





(1,12) .044 DIA



No. of positions x (1,27) .050 + (3,58) .141

 $= 10 \mu$ " =Four (0,25µm) Gold on Rows contact area -05Matte Tin on =Five solder tail Rows -S -06 $= 30 \mu''$ =Six (0,76µm) Gold on Rows contact area -08 Matte Tin on =Eight

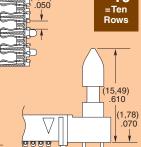
solder tail

Performance data for other stack heights

available at www.samtec.com?SEAF

PLATING

OPTION



-LP

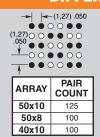
2 = Lead-Free Tin Alloy 95.5% Sn/3.8% Ag/0.7% Cu Solder Charge

.LP =Latch Post (-LP required for SEAC mate only)

APPLICATION SPECIFIC OPTION

-07.5 lead style for 30x4 available. Call Samtec.

DIFFERENTIAL



ARRAY	PAIR COUNT	
40x8	80	
40x6	60	
30x10	75	
30x8	60	
30x6	45	
20x10	50	
20x8	40	
20x10	25	

Note: Some sizes, styles and options are non-standard. non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM

(0,20)